

Restricted

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1. Introduction

The MPC2520 is a new generation of high precision digital pressure sensor developed by MaierTek Inc. for consumer applications

The ultra-low power, low voltage electronics of the MPC2520 is optimized for use in mobile phones, wearables, GPS navigation devices and outdoor equipments.

With a low altitude noise of merely 4 cm at fast conversion time, the MPC2520 offers superior performance.

The I2C interface allows for easy system integration with microcontroller.

Key features

- Pressure range: 300 ... 1100Pa (+9000m ... -500m relating to sea level)
- Supply voltage: 1.8 ... 3.6V (VDD)
- Package: LGA package with metal lid
 - Small footprint: 2mm x 2.5mm; Super-flat: 0.95mm height
- Low noise: 0.5Pa (4cm)
- Temperature measurement included
- I2C interface mainly, reserved SPI port
- Fully calibrated
- Pb-free, halogen-free and RoHS compliant,

Typical applications

- Enhancement of GPS navigation (dead-reckoning, slope detection, etc.)
- In- and out-door navigation
- UAV Coper
- Leisure and sports
- Weather forecast
- Vertical velocity indication (rise/sink speed)

2. Test condition

Table 1: Test condition

Standard Conditions	Temperature	Humidity	Air pressure
Environment conditions	-40℃-85℃	25%RH-85%RH	300hPa-1100hPa
Basic test conditions	25℃	60%RH-70%RH	300hPa-1100hPa

3. Absolute maximum ratings

Table 2: Absolute maximum ratings

Parameter	Condition	Min	Max	Units
Storage temperature		-40	125	°C
Supply Voltage	All pin	-0.3	+4.25	V
ESD rating	HBM,R=1.5kohm,C=100pF		±2	kV
Overpressure			10000	hPa

4. Electrical characteristics

If not stated otherwise, the given values are ± 3 -Sigma values over temperature/voltage range in the given operation mode. All values represent the new parts specification; the additional solder drift is shown separately.

Table 3: Operating conditions, output signal and mechanical characteristics

Parameter	Symbol	Condition	Min	Туре	Max	Units
Operating	TA	Operational	-40		85	°C
temperature	IA	Full accuracy	0		70	°C
Operating Pressure	Р		300		1100	hPa
Supply voltage	Vdd	Ripple max.50mVpp	1.8		3.6	V
Supply current @25°C	Iddstd	Standard mode		3		μА
Peak current	Ipeak	During conversion		900	1500	μА
standby current	Iddsbm	@25°C		20	250	nA
Relative accuracy		800-1100 hPa		$\pm 0.06^{(1)}$		hPa
pressure		@ 25 °C		±0.5		m
Absolute accuracy		260- 1260 hPa		(1)		hPa
pressure		@-20°C- +65 °C		±1 ⁽¹⁾		
Resolution of		Pressure		0.06		Pa
output data		Temperature		0.5		°C
Noise in pressure				0.01		PaRMS
Absolute accuracy temperature		@-20°C- +70 °C		±0.5		°C
Conversion time pressure	tc_p	Low Power Mode Standard mode High Precision Mode		5/28/105		ms
Conversion time temperature	tc_temp	Standard mode		5		ms
Serial data clock		For I2C		20		MHz
Solder drifts			-0.5 ⁽¹⁾		2 ⁽¹⁾	hPa

		. (1)	
Long term stability	12month	±1 ⁽¹⁾	hPa

1. It is target performance.

5. Operation

5.1 General description

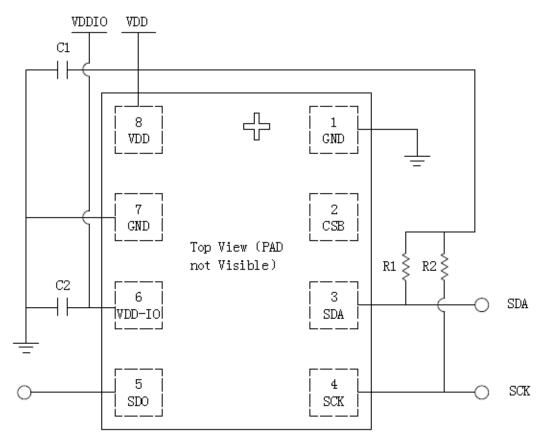
The MPC2520 is designed to be connected directly to a microcontroller of a mobile device via the I2C or SPI bus. The pressure and temperature data has to be compensated by the calibration data of the MTP of the MPC2520.

5.2 General function and application schematics

The MPC2520 consists of a capacitive sensor, an analog to digital converter and a control unit with MTP and a serial I2C and SPI interfaces. The sensor delivers the uncompensated value of pressure and temperature. The MTP has stored several individual calibration data used to compensate offset, temperature dependence and other parameters of the sensor.

UP = pressure data (24 bit)

UT = temperature data (24 bit)



I2C Adreess

0x76(SDO pulled-down to GND)

0x77(SDO pulled-down to VDD or NC)

Figure 1: Typical application circuit

	1.0		аррисан				
Commonant	Cymala ol		Values		Unit	Note / Test Condition	
Component	Symbol	Min.	Тур.	Max.	Unit		
Pull-up/down Resistor	R_1, R_2	5		100	ΚΩ	R_2 is optional and will set the address to $0x76$ instead of $0x77$.	
Supply Blocking Capacitor	C ₁ , C ₂	100	100		nF	The blocking capacitors should be placed as close to the package pins as possible.	

5.3 Measurement of pressure and temperature

The microcontroller sends a start sequence to start a pressure or temperature measurement. After converting time, the result value (UP or UT, respectively) can be read via the I2C interface. For calculating temperature in degree and pressure in hPa, the calibration data has to be used. These constants can be read out via the I2C interface at software initialization.

The sampling rate can be increased up to 128 samples per second for dynamic measurement. In this case, it is sufficient to measure the temperature only once per second and to use this value for all pressure measurements during the same period.

5.4 Calculating absolute altitude and calculating pressure at sea level

With the measured pressure P and the pressure at sea level P_0 =1013.25hPa, the altitude in meters can be calculated with the international barometric formula:

Altitude =
$$44330 \times \left[\mathbf{1} - \left(\frac{\mathbf{P}}{P_0} \right)^{\frac{1}{5.255}} \right]$$

Thus, a pressure change of $\Delta p = 1$ hPa corresponds to 8.43m at sea level.

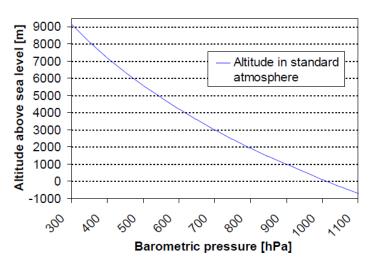


Figure 2: Transfer function: Altitude over sea level - Barometric pressure

With the measured pressure p and the absolute altitude the pressure at sea level can be calculated:

$$P_0 = \frac{p}{\left(1 - \frac{\text{altitude}}{44330}\right)^{5.255}}$$

Thus, a difference in altitude of \triangle altitude = 10m corresponds to 1.2hPa pressure change at sea level.

5.5. I2C Interface

- I2C is a digital two wire interface
- Clock frequencies up to 3.4Mbit/sec.
- SCL and SDA needs a pull-up resistor, typ. 4.7kOhm to VDDIO (one resistor each for all the I2C bus)
- The I2C bus is used to control the sensor, to read calibration data from the MTP and to read the measurement data when A/D conversion is finished. SDA (serial data) and SCL (serial clock) have open-drain outputs.

In I^2C Mode, each command is started as shown in figure 3. Only the number of bytes that is needed for the command has to be sent. After the execution of a command (busy = 0) the expected data can be read as illustrated in figure 4. or if no data are returned by the command the next command can be sent. The status can be read at any time as described in figure 5.

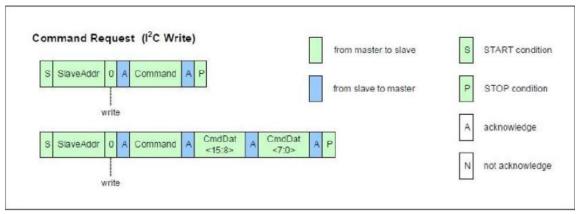


Figure 3 I2C Command Request

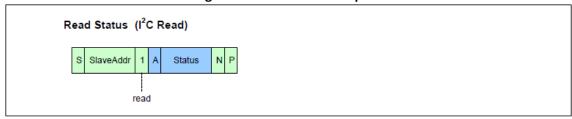


Figure 4 I2C Read Status

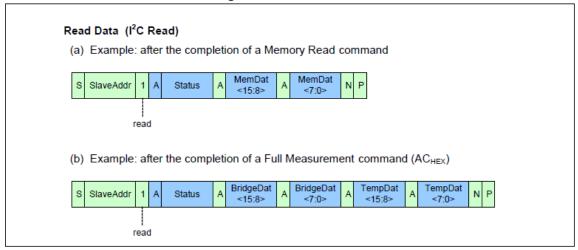


Figure 5 I2C Read Data

All mandatory I²C-bus protocol features are implemented. Optional features like clock stretching, 10-bit slave address, etc., are not supported by the MPC2520 interface.

In I²C-High Speed Mode, a command consists of a fixed length of three bytes.

The I2C commands supported by the MPC2520 are listed in Table 4.

The commands to read an address in the user memory is the same as its address.

6 Calibration and Measurement Compensation

The MPC2520 is a calibrated sensor and contains calibration coefficients. These are used in the application (for instance by the host processor) to compensate the measurement results for sensor non-linearity's.

The sections that follow, describe how to calculate the compensated results and convert them into Pa and °C values.

6.1 How to Calculate Compensated Pressure Values

- 1. Read the calibration coefficients (c00, c10, c20, c30, c01, c11, and c21) from the Calibration Coefficient register. *Note: The coefficients read from the coefficient register are 16 bit 2's complement numbers.*
- 2. Choose scaling factors kT (for temperature) and kP (for pressure) based on the chosen precision rate. The scaling factors are listed in *Table 4*.
- 3. Read the pressure and temperature result from the registers or FIFO.

Note: The measurements read from the result registers (or FIFO) are 24 bit 2's complement numbers.

Depending on the chosen measurement rates, the temperature may not have been measured since the last pressure measurement.

4. Calculate scaled measurement results.

$$\begin{array}{l} T_{raw_sc} \\ = T_{raw}/kT & P_{raw_sc} \\ = P_{raw}/kP & \end{array}$$

5. Calculate compensated measurement results.

$$\begin{split} P_{comp}(Pa) &= c00 \\ *(c11 + P_{raw_sc}*(c10 + P_{raw_sc} *(c20 + P_{raw_sc} *c30)) + T_{raw_sc}*c01 + T_{raw_sc} *P_{raw_sc} *(c11 + P_{raw_sc}*c21) \end{split}$$

6.2 How to Calculate Compensated Temperature Values

1. Read the calibration coefficients (c0 and c1) from the *Calibration Coefficients* (COEF) register.

Note: The coefficients read from the coefficient register are 12 bit 2 's complement numbers.

- 2. Choose scaling factor kT (for temperature) based on the chosen precision rate. The scaling factors are listed in *Table 4*.
- 3. Read the temperature result from the temperature register and FIFO.

Note: The temperature measurements read from the temperature result register (or FIFO) are 24 bit 2's complement numbers.

4. Calculate scaled measurement results.

$$T_{raw_sc} = T_{raw}/kT$$

5. Calculate compensated measurement results

$$T_{comp}$$
 (°C) = c0*0.5 + c1* T_{raw_sc}

6.3 Compensation Scale Factors

 Table 4
 Compensation Scale Factors

Oversampling Rate	Scale Factor (kP or kT)
1 (single)	524288
2 times (Low Power)	1572864
4 times	3670016
8 times	7864320
16 times (Standard)	253952
32 times	516096
64 times (High Precision)	1040384
128 times	2088960

7. Register Map

 Table 7
 Register Map

Register Name	Addr.	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	Reset State	
PSR_B2	0x00	PSR[23:16	[] (r)							00 _h	
PSR_B1	0x01	PSR[15:8]	SR[15:8](r)								
PSR_B0	0x02	PSR[7:0](SR[7:0](r)								
TMP_B2	0x03	TMP[23:10	6] (r)							00_{h}	
TMP_B1	0x04	TMP[15:8]	(r)							00 _h	
TMP_B0	0x05	TMP[7:0] ((r)							00 _h	
PRS_CFG	0x06	-	PM_RATE[2	::0] (rw)		PM_PRC [3:0] (rw)			00 _h	
TMP_CFG	0x07	TMP _EXT (rw)	TMP_RATE[2:0] (rw)						00 _h		
MEAS_CFG	0x08	COEF_ RDY (r)	SENSOR _RDY(r)	TMP_ RDY (r)	PRS_ RDY (r)	- MEAS_CRTL[2:0] (rw)				00 _h	
CFG_REG	0x09	INT_ HL (rw)	INT_SEL[2	INT_ SEL [2:0] (rw)			PRS_ SHIFT_ EN (rw)	FIFO_ EN(rw)	SPI_ MOD E	00 _h	
INT_STS	0x0A	-	-	-	-	-	INT_ FIFO_ FULL (r)	INT_ TMP(r)	INT_ PRS(r	00 _h	
FIFO_STS	0x0B	-	-	-	-	-	-	FIFO_ FULL(r)	FIFO_ EMPTY(r)	00 _h	
RESET	0x0C	FIFO_ FLUSH (w)	-	-	-	SOFT_RST	[3:0] (w)			00 _h	
ID	0x0D	PROD_ID	[3:0] (r)			REV_ID[3	:0] (r)			00h	
COEF	0x10- 0x21	< see regis	ster description	ı >						XX _h	
Reserved	0x22- 0x27	Reserved								XX _h	
COEF_SRCE	0x28	TMP_C OEF_S RCE(r)	Reserved							XXh	

8. Register Description

8.1Pressure Data (PRS_Bn)

The Pressure Data registers contains the 24 bit (3 bytes) 2's complement pressure measurement value.

If the FIFO is enabled, the register will contain the FIFO pressure and/or temperature results (please see *FIFO Operation*). Otherwise, the register contains the pressure measurement results and will not be cleared after read.

8.1.1 PRS_B2

The highest byte of the three bytes measured pressure value.

PRS_B2			Address:						
Pressure (MSI	3 data)			Reset value:					
7	6		5	4 3 2 1					
PRS23	PRS2	2 F	PRS21	PRS20	PRS20 PRS19 PRS18 PRS1				
				r					
Field		Bits	Type	Description					
PRS[23:16]		7:0	r	MSB of 24 bit 2's complement pressure data.					

8.1.2 PRS_B1

The middle byte of the three bytes measured pressure value.

PRS_B1			Address:						
Pressure (LSB	data)			Reset value:					
7	6		5	4	3	2	1	0	
PRS15	PRS14	1 P	RS13	PRS12	PRS12 PRS11 PRS10 PRS9				
				r					
Field	E	Bits	Type	Description					
PRS[15:8]	7	7:0	r	LSB of 24 bit 2's complement pressure data.					

8.1.3 PRS_B0

The lowest byte of the three bytes measured pressure value.

PRS_B0			Address:						
Pressure (XLS	B data)			Reset value:					
7	6		5	4 3 2 1				0	
PRS7	PRS	6 F	PRS5	PRS4	PRS3	PRS1	PRS0		
				r					
Field		Bits	Type	Description					
PRS[7:0]		7:0	r	XLSB of 24 bit 2's complement pressure data.					

8.2 Temperature Data (TMP_Tn)

The Temperature Data registers contain the 24 bit (3 bytes) 2's complement temperature measurement value (unless the FIFO is enabled, please see *FIFO Operation*) and will not be cleared after the read.

8.2.1 TMP_B2

The highest byte of the three bytes measured temperature value.

TMP_B2			Address:			03_{H}		
Temperature (1	MSB dat	a)		Re	set value:			$00_{\rm H}$
7	6		5	4	3	2	1	0
TMP23	TMP	22 T	MP21	TMP20	TMP19	TMP18	TMP17	TMP16
		,		r				
Field		Bits	Type	Description	n			
TMP[23:16]		7:0	r MSB of 24 bit 2 's complement temperature data.					

8.2.2 TMP_B1

The middle byte of the three bytes measured temperature value.

TMP_B1 Temperature (l	LSB data)			Re	Address: eset value:	$04_{ m H}$ $00_{ m H}$		
7	6		5	4	3	2	1	0
TMP15	TMP14	1 Ti	MP13	TMP12	TMP11	TMP10	TMP9	TMP8
				r				
Field	В	Bits	Type	Description	n			
TMP[15:8]	7	::0	r	LSB of 24 bit 2's complement temperature data.				

8.2.3 TMP_B0

The lowest part of the three bytes measured temperature value.

TMP_B0	VI CD do	to)		D.	Address: Reset value:				
Temperature (2	ALSB da	ia)		Re	eset value:			$00_{\rm H}$	
7	6		5	4	3	2	1	0	
TMP7	TMI	P6	TMP5	TMP4	TMP3	TMP2	TMP1	TMP0	
				1	r				
Field		Bits	Type	Descriptio	Description				
TMP[7:0]		7:0	r	XLSB of 2	XLSB of 24 bit 2's complement temperature data.				

8.3 Pressure Configuration (PRS_CFG)

Configuration of pressure measurement rate (PM_RATE) and resolution (PM_PRC).

PRS_CFG				Address:			06 _H		
Pressure measure	ement configu	uration	Re	Reset value:					
7	6	5	4	3	2	1	0		
-	PN	M_RATE[2:0]			PM_P	RC[3:0]			
-		rw		rw					
Field	Bits	Type	Description	n					
-	7	-	Reserved.						
PM_RATE[2:0]	6:4	rw	Pressure r	neasurement ra	nte:				
			000 - 1 me	asurements pr.	sec.				
			001 - 2 me	asurements pr.	sec.				
			10 -4 me	asurements pr.	sec.				
			11 -8 me	asurements pr	sec.				
			100 - 16 m	easurements pr	sec.				
101 - 32 measurements pr. sec.									
			110 - 64 m	easurements pr	: sec.				
			111 - 128 r	neasurements p	or sec.				
			Applicable	Applicable for measurements in Background mode only					

PM_PRC[3:0]	3:0	rw	Pressure oversampling rate:
			0000 - Single.
			0001 - 2 times (Low Power).
			0010 - 4 times.
			0011 - 8 times.
			0100 *)- 16 times (Standard).
			0101 *) - 32 times.
			0110*)-64 times (High Precision).
			0111 *) - 128 times.
			1xxx - TBD

^{*)} Note: Use in combination with a bit shift. See *Interrupt and FIFO configuration (CFG_REG)* register

Table 8 Pressure measurement time (ms) and precision (PaRMS)

Oversampling (PRC[3:0])	Single (0000)	2 times (0001)	4 times (0010)	8 times (0011)	16 times (0100)	32 times (0101)	64 times (0110)	128 times (0111)
Measurement time (ms)	3.6	5.2	8.4	14.8	27.6	53.2	104.4	206.8
Precision (Pa _{RMS})	5		2.5		1.2	0.9	0.5	_

 Table 9
 Estimated current consumption (uA)

Oversampling (PRC[3:0]) Measurements pr sec. (PM_RATE([2:0])	Single (0000)	2 times (0001)	4 times (0010)	8 times (0011)	16 times (0100)	32 times (0101)	64 times (0110)	128 tim es (0111)
1 (000)	2.1	2.7	3.8	6.1	11	20	38	75
2 (001)								
4 (010)								
8 (011)	Note: The current consumption—can be calculated as the Measurement Rate * Current Consumption of 1 measurement per. sec.							n.a.
16 (100)							n.a.	n.a.
32 (101)						n.a.	n.a.	n.a.
64 (110)					n.a.	n.a.	n.a.	n.a.
128 (111)			n.a.	n.a.	n.a.	n.a.	n.a.	n.a.

Note: The table shows the possible combinations of Pressure Measurement Rate and oversampling when no temperature measurements are performed. When temperature measurements are performed the possible combinations are limited to Rate temperature x Measurement Time temperature x Rate x Measurement Time temperature x Measurement x Measurement

< 1 second.

8.4 Temperature Configuration (TMP_CFG)

TMP_CFG				Address:			07_{H}	
Temperature mea	asurement con	figuration	R	leset value:			00_{H}	
7	6	5	4	3	2	1	0	
TMP_EXT	TM	P_RATE[2:0]	- TMP_PRC[3:0]					
rw		rw		-		rw		
Field	Bits	Type	Description	on				
TMP_EXT	7	rw	Temperat	ure measuren	nent			
			0 - Interna	ıl sensor (in AS	SIC)			
			1 - Externa	al sensor (in pr	essure sensor N	MEMS element)		
			Note: Ple	ase use the ex	ternal sensor se	etting.		
TMP_RATE[2:0]	6:4	rw	Temperat	ure measurem	nent rate:			
			000 - 1 measurement pr. sec.					
			001 - 2 measurements pr. sec.					
			10 -4 me	easurements p	er sec.			
			11 -8 me	easurements p	r sec.			
			100 - 16 n	neasurements	pr. sec.			
			101 - 32 n	neasurements	pr. sec.			
			110 - 64 n	neasurements	pr. sec.			
			111 - 128 measurements pr. sec.					
			Applicabl	e for measuren	nents in Backgro	ound mode only		
TMP_PRC[3:0]	2:0	rw	Temperatu	ıre oversampli	ng (precision)	:		
			000 - sing	le. (Default) - N	Measurement tin	ne 3.6 ms. <i>Note:</i>		
			Following are optional, and may not be relevant: 001 - 2					
			times.					
			10 -4 tin	nes.				
			11 -8 tin	nes.				
			100 - 16 ti					
			101 - 32 ti					
			110 - 64 ti					
			111 - 128	times.				
			1xxx-TB	D.				

8.5 Sensor Operating Mode and Status (MEAS_CFG)

Setup measurement mode.

MEAS_CFG				Address:			$08_{\rm H}$		
Measurement	configuration		Re	eset value:			$00_{\rm H}$		
7	6	5	4	3	2	1	0		
COEF_RDY	SENSOR_R DY	TMP_RDY	PRS_RDY	-		MEAS_CTRL			
r	r	r	r	-		rw			
Field	Bits	Type	Description	n					
COEF_RDY	7	r	- Coefficie	Coefficients will be read to the Coefficients Registers after start- up: 0 - Coefficients are not available yet. 1 - Coefficients are available.					
SENSOR_RDY	6	r	The pressustart-up. 0 - Sensor 1 - Sensor It is recon	- Sensor initialization not complete - Sensor initialization complete is recommend not to start measurements until the sensor					
TMP_RDY	5	r	completed the self initialization. Temperature measurement ready 1 - New temperature measurement is ready. Cleared who temperature measurement is read.						
PRS_RDY	4	r	Pressure r 1 - New p	measurement i	ready surement is	ready. Cleared v	when		
_	3	-	Reserved.						

MEAS_CTRL	2:0	rw	Set measurement mode and type:
			Standby Mode
			1 - Idle / Stop background measurement
			Command Mode
			2 - Pressure measurement 010
			- Temperature measurement
			011 - na.
			100 - na.
			Background Mode
			101 - Continuous pressure measurement
			110 - Continuous temperature measurement
			111 - Continuous pressure and temperature measurement

8.6 Interrupt and FIFO configuration (CFG_REG)

Configuration of interrupts, measurement data shift, and FIFO enable.

CFG_REG				Address:			09 _H			
Configuration	register		Re	eset value:			00_{H}			
7	6	5	4	3	2	1	0			
INT_HL	INT_FIFO	INT_PRS	INT_TMP	T_SHIFT	P_SHIFT	FIFO_EN	SPI_MODE			
rw	rw	rw	rw	rw	rw	rw	rw			
Field	Bits	Type	Descriptio	n						
INT_HL	7	rw	Interrupt (on SDO pin) ac	tive level:					
			0-Active lo	OW.						
			1-Active h	igh.						
INT_FIFO	6	rw	Generate in	nterrupt when	the FIFO is full	:				
			0 - Disable							
			1 - Enable.	1 - Enable.						
INT_PRS	5	rw	Generate in	nterrupt when	a pressure m	neasurement is	ready:			
			0 - Disable							
			1 - Enable.							
INT_TMP	4	rw	Generate	interrupt wh	en a temperatu	re measuremei	nt is ready:			
			0 - Disable	•						
			1 - Enable.							
T_SHIFT	3	rw	Temperature result							
			bit-shift 0 - no shift.							
			1 - shift res	ult right in dat	a register.					
			Note: Musi	be set to '1' wh	en the oversan	npling rate is>	8 times.			
P_SHIFT	2	rw	Pressure re	esult bit-shift						
			0 - no shift	•						
			1 - shift res	ult right in dat	a register.					
		Note: Must be set to '1' when the oversampling rate is >8 times.								
FIFO_EN	1	rw	Enable the FIFO:							
			0 - Disable							
			1 - Enable.							

SPI_MODE	0	rw	Set SPI mode:
			0 - 4-wire interface.
			1 - 3-wire interface.

8.7 Interrupt Status (INT_STS)

Interrupt status register. The register is cleared on read.								
INT_STS				Address:			$0A_{H}$	
Interrupt status	Interrupt status Reset value:						$00_{\rm H}$	
7	6	5	4	3	2	1	0	
		-			INT_FIFO_F ULL	INT_TMP	INT_PRS	
		-			r	r	r	
Field	Bits	Type	Description					
-	7:3	-	Reserved.					
INT_FIFO_FULL	2	r	Status of FII	O interrupt				
			0 - Interrupt	not active				
			1 - Interrupt	active				
INT_TMP	1	r	Status of temperature measurement interrupt					
			0 - Interrupt	not active				
			1 - Interrupt	active				
INT_PRS	0	r	Status of pre	ssure measi	urement interru	pt 0		
			- Interrupt n	ot active				

1 - Interrupt active

8.8 FIFO Status (FIFO_STS)

FIFO status	register							
FIFO_STS	TFO_STS Address:							
FIFO status	register	ister Reset value: 00						
7	6		5	4	3	2	1	0
			-				FIFO_FULL	FIFO_EMPT
								Y
			-				r	r
Field		Bits	Туре	Description				
-		7:2	-	Reserved.				

FIFO_FULL	1	r	0 - The FIFO is not full
			1 - The FIFO is full
FIFO_EMPTY	0	r	0 - The FIFO is not empty
			1 - The FIFO is empty

8.9 Soft Reset and FIFO flush (RESET)

Flush FIFO or generate soft reset.

riusii riro oi gen	ierate son rese	ι.					
RESET			Address:				$0C_{H}$
FIFO flush and soft reset			Re	Reset value:			
7	6	5	4	3	2	1	0
FIFO_FLUSH		-			SOFT	_RST	
W		-			7	v	
Field	Bits	Type	Description	n			
FIFO_FLUSH	7	w	FIFO flush				
			1 - Empty I	FIFO			
			After reading	ng out all data f	from the FIFO,	write '1' to clea	ar all old data.
-	6:4	-	Reserved.				
SOFT_RST	3:0	w		l' to generate a uences as in po			in though the

8.10 Product and Revision ID (ID)

Product and Revision ID.

ID Product and revision	ID			ddress: value:			$0D_{\rm H}$ $0x00_{\rm H}$
7	5	5	4	3	2	1	0
PROD_ID					REV_ID		
	r				r		
Field	Bits	Type	Description				
PROD_ID	7:4	r	Product ID				
REV_ID	3:0	r	Revision ID				

8.11 Calibration Coefficients (COEF)

The Calibration Coefficients register contains the 2's complement coefficients that are used to calculate the compensated pressure and temperature values.

 Table 10
 Calibration Coefficients

Coefficient	Addr.	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
c0	0x10	c0 [11:4]							
c0/c1	0x11	c0 [3:0]				c1 [11:8]			
c1	0x12	c1[7:0]							
c00	0x13	c00 [19:1	12]						
c00	0x14	c00 [11:4	1]						
c00/c10	0x15	c00 [3:0]				c10 [19:1	16]		
c10	0x16	c10 [15:8	c10 [15:8]						
c10	0x17	c10 [7:0]							
c01	0x18	c01 [15:8	3]						
c01	0x19	c01 [7:0]							
c11	0x1A	c11 [15:8	3]						
c11	0x1B	c11 [7:0]							
c20	0x1C	c20 [15:8	3]						
c20	0x1D	c20 [7:0]	c20 [7:0]						
c21	0x1E	c21 [15:8	c21 [15:8]						
c21	0x1F	c21 [7:0]	c21 [7:0]						
c30	0x20	c30 [15:8	c30 [15:8]						
c30	0x21	c30 [7:0]							

9. Mechanical characteristics

9.1 Pin configuration

Picture shows the device in top view. Device pins are shown here transparently only for orientation purposes.

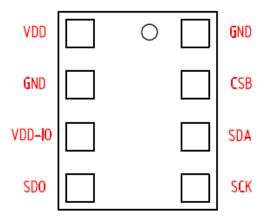


Figure 6: Layout pin configuration MPC2520

Table 5: Pin configuration of MPC2520

Pin No.	Name	Function		
1	GND	Ground		
2	CSB	Chip select		
3	SDA	Data		
4	SCK	Clock		
5	SDO	NC		
6	VDDIO	NC		
7	GND	Ground		
8	VDD	Power supply		

9.2 Outline dimensions

The sensor housing is a 7Pin LGA package with metal lid. Its dimensions are 2mm (± 0.1 mm) x 2.5mm (± 0.1 mm) x 0.95mm (± 0.05 mm).

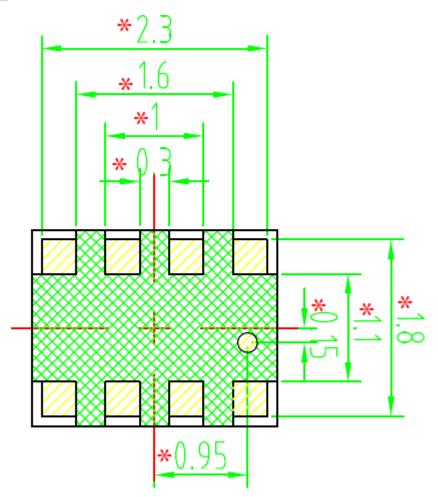


Figure 7: Bottom view of MPC2520

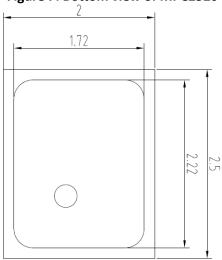


Figure 8: Top view of MPC2520

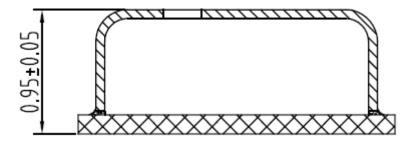


Figure 9: Side view of MPC2520

10. Storage and transportation

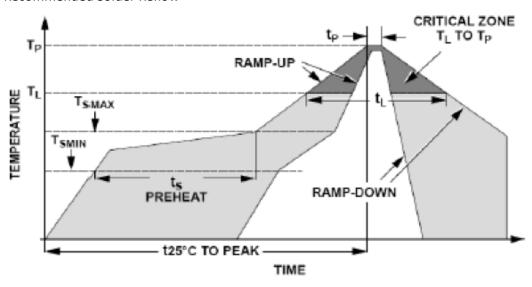
- Keep in warehouse with less than 75% humidity and without sudden temperature change, acid air, any other harmful air or strong magnetic field.
- The MEMS pressure sensor with normal pack can be transported by ordinary conveyances. Please protect products against moist, shock, sunburn and pressure during transportation.
- Storage Temperature Range: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$
- Operating Temperature Range: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$

11. Soldering recommendation

Standard Reflow sodering condition

Reference	J-STD-020-C,J-STD-033							
Maximum Peak		280 ℃						
Temperature								
Mositure		MSL 3						
sensitivity level								
Bake condition		Exposure	Exposure					
		Time>72hours	Time<72hours					
	Bake @125°C	9 hours	7 hours					
	Bake @90°C,<5% RH	33 hours	23 hours					
	Bake @40°C, <5% RH	13 days	9 days					

Recommended Solder Reflow



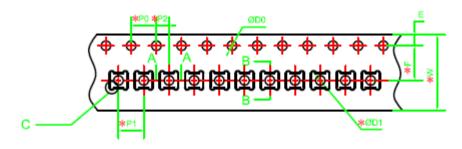
Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/seconds max.
Preheat	
-Temperature Min.(Tsmin)	150℃
-Temperature Max.(Tsmax)	200℃
-Time(Tsmin to Tsmax)(Ts)	$60{\sim}80$ seconds
Time maintained above:	
-Temperature(T _L)	217℃
-Time(t _L)	$60{\sim}150$ seconds
Peak temperature(Tp)	260℃

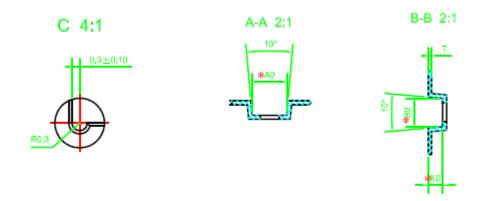
Maier Microelectronics Technology Co.Ltd

Time within 5℃ of actual peak temperature(Tp)2	20~40seconds
Ramp-down rate	4°C/seconds max.
Time 25 ℃ to peak temperature	8 minutes max.

12. Package Specifications

Carrier Tape Information [Unit: mm]





ITEM	*W	E	*F	∗ØD0	ØD1
DIM(mm)	12.00±0.30	1.75±0.10	5.50±0.10	1.50+0.10	1.50 +0.10
ITEM	*P0	*10P0	*P1	*A0	*B0
DIM(mm)	4.00±0.10	40.00±0.20	4.00±0.10	2.75±0.05	2,25±0,05
ITEM	*K0	*P2	Т		
DIM(mm)	1.15±0.05	2.00±0.10	0.30±0.05		

Figure 7: Carrier Tape (1)

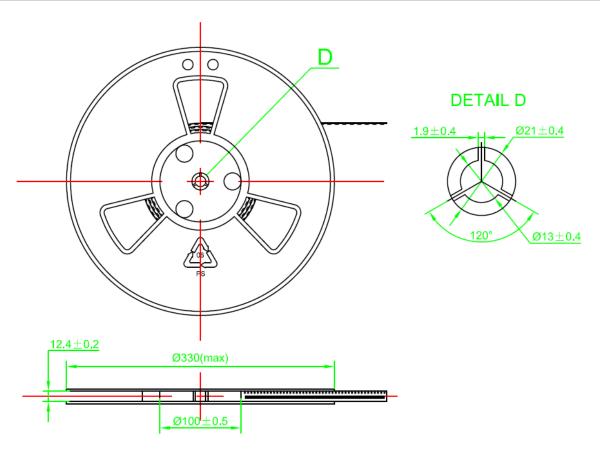
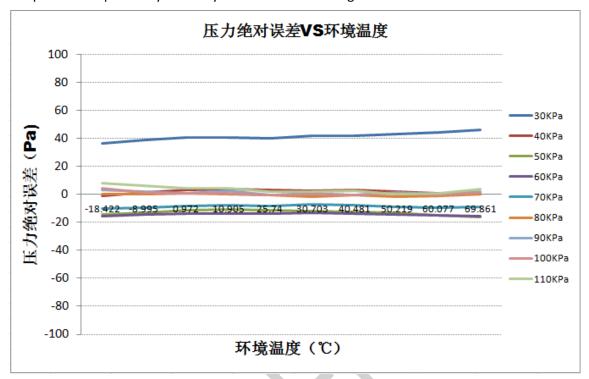


Figure 8: Carrier Tape (2)

Appendix 1: Temperature Dependency Accuracy Curve as the following:



Temperature Dependency Accuracy Curve